
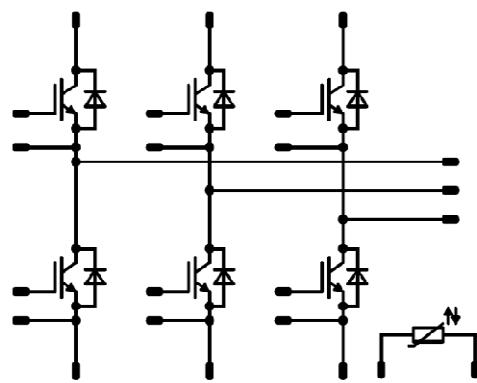




Vincotech

<i>flow PACK 2</i>	1200 V / 50 A
<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;">Features</div> <ul style="list-style-type: none"> IGBT4 (1200 V) technology for low saturation losses and improved EMC behavior Compact and low inductive design Integrated temperature sensor 	<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;"><i>flow 2 17 mm housing</i></div> 
<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;">Target applications</div> <ul style="list-style-type: none"> Industrial drives 	<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;">Schematic</div> 
<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;">Types</div> <ul style="list-style-type: none"> 30-P2126PA050SC-L287F09Y 	

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	65	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	185	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$T_j \leq 150\text{ °C}$	10	μs
	V_{CC}	$V_{GE} = 15\text{ V}$	800	V
Maximum Junction Temperature	T_{jmax}		175	°C



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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Diode				
Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	65	A
Repetitive peak forward current	I_{FRM}		100	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	127	W
Maximum Junction Temperature	T_{jmax}		175	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{top}		-40...(T _{jmax} - 25)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage $t_p = 2\text{ s}$	4000	V
Creepage distance			min. 12,7	mm
Clearance			min. 12,7	mm
Comparative Tracking Index	CTI		> 200	



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Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,0017	25 125	5,3	5,8	6,3	V
Collector-emitter saturation voltage	V_{CEsat}		15		50	25 150	1,58	1,88 2,30	2,07	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			1	μA
Gate-emitter leakage current	I_{GES}		20	0		25			120	nA
Internal gate resistance	r_g							4		Ω
Input capacitance	C_{ies}	$f = 1$ MHz	0	25		25		2800		pF
Reverse transfer capacitance	C_{res}							100		

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4$ W/mK						0,51		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{goff} = 8$ Ω $R_{gon} = 8$ Ω	±15	600	50	25		96		ns
Rise time	t_r					150		101		
Turn-off delay time	$t_{d(off)}$					25		17		
Fall time	t_f					150		24		
Turn-on energy (per pulse)	E_{on}					25		214		
Turn-off energy (per pulse)	E_{off}	$Q_{rFWD} = 4,8$ μC $Q_{tFWD} = 9,7$ μC				150		281		mWs
						25		87		
						150		122		
						25		2,701		
						150		4,211		
						25		2,744		
						150		4,531		



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Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max		

Inverter Diode

Static

Parameter	Symbol	V_{GS} [V]	V_{DS} [V]	I_D [A]	I_F [A]	T_j [°C]	Min	Typ	Max	Unit
Forward voltage	V_F			50		25 125 150		1,73 1,70 1,68	2,05	V
Reverse leakage current	I_r		1200			25			10	μA

Thermal

Parameter	Symbol	Conditions	T_j [°C]	Min	Typ	Max	Unit
Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4$ W/mK			0,75		K/W

Dynamic

Parameter	Symbol	Conditions	T_j [°C]	Min	Typ	Max	Unit	
Peak recovery current	I_{RRM}		25 150		81 85		A	
Reverse recovery time	t_{rr}		25 150		139 316		ns	
Recovered charge	Q_r	$di/dt = 3866$ A/μs $di/dt = 2820$ A/μs	±15	600	50	25 150	4,797 9,708	μC
Reverse recovered energy	E_{rec}		25 150		1,790 3,972		mWs	
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		25 150		4803 1209		A/μs	

Thermistor

Parameter	Symbol	Conditions	T_j [°C]	Min	Typ	Max	Unit
Rated resistance	R		25		22		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	$R_{100} = 1486$ Ω	100	-12		+14	%
Power dissipation	P		25		200		mW
Power dissipation constant			25		2		mW/K
B-value	$B_{(25/50)}$	Tol. ±3%	25		3950		K
B-value	$B_{(25/100)}$	Tol. ±3%	25		3998		K
Vincotech NTC Reference						B	

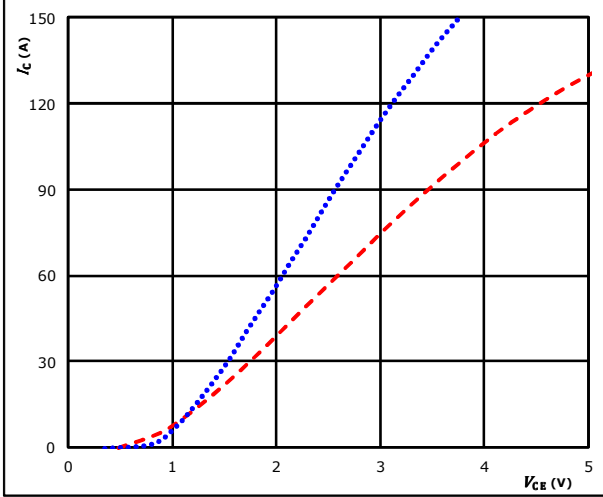


Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics

$I_C = f(V_{CE})$

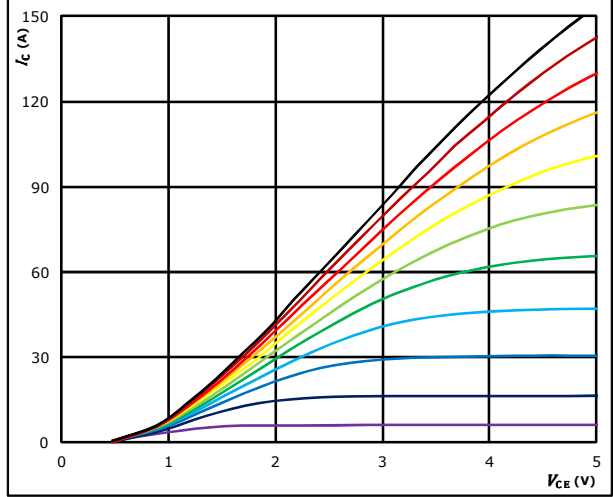


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j: 25 \text{ } ^\circ C$ (blue dotted line)
 $150 \text{ } ^\circ C$ (red dashed line)

figure 2. IGBT

Typical output characteristics

$I_C = f(V_{CE})$

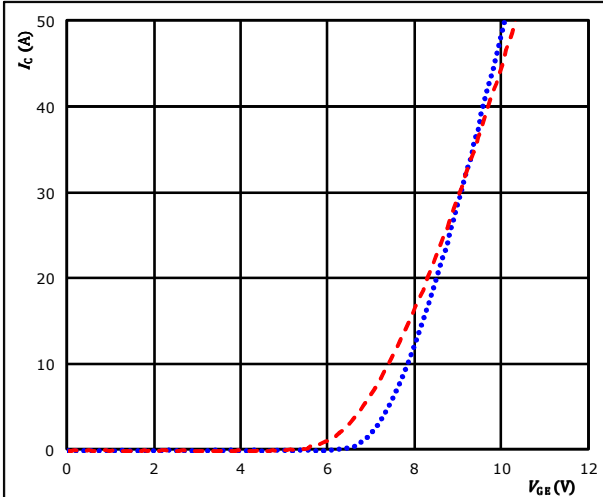


$t_p = 250 \mu s$
 $T_j = 150 \text{ } ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$I_C = f(V_{GE})$

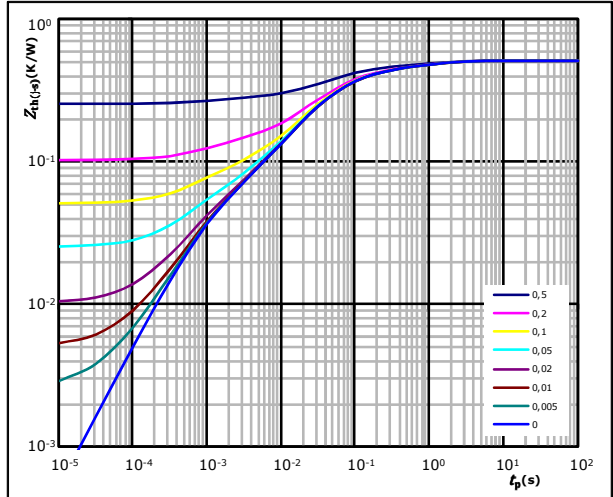


$t_p = 100 \mu s$
 $V_{CE} = 10 V$
 $T_j: 25 \text{ } ^\circ C$ (blue dotted line)
 $150 \text{ } ^\circ C$ (red dashed line)

figure 4. IGBT

Transient Thermal Impedance as function of Pulse duration

$Z_{th(j-s)} = f(t_p)$



$D = t_p / T$
 $R_{th(j-s)} = 0,51 \text{ K/W}$

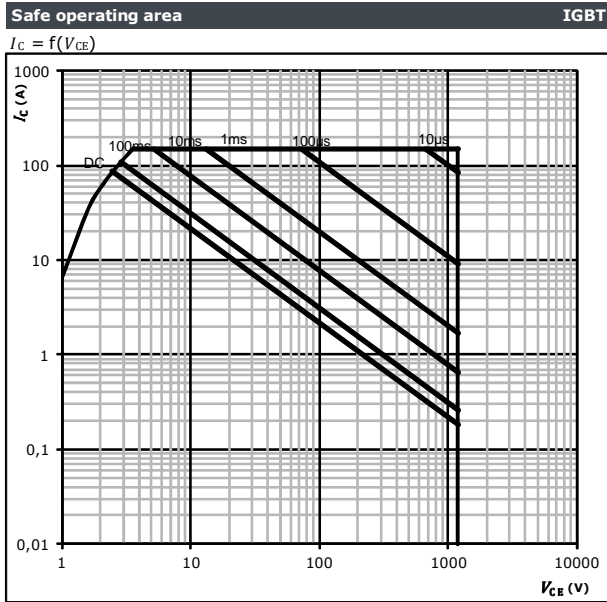
IGBT thermal model values

R (K/W)	τ (s)
7,12E-02	1,13E+00
1,15E-01	1,65E-01
2,22E-01	3,78E-02
6,59E-02	1,21E-02
3,86E-02	9,52E-04



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Inverter Switch Characteristics



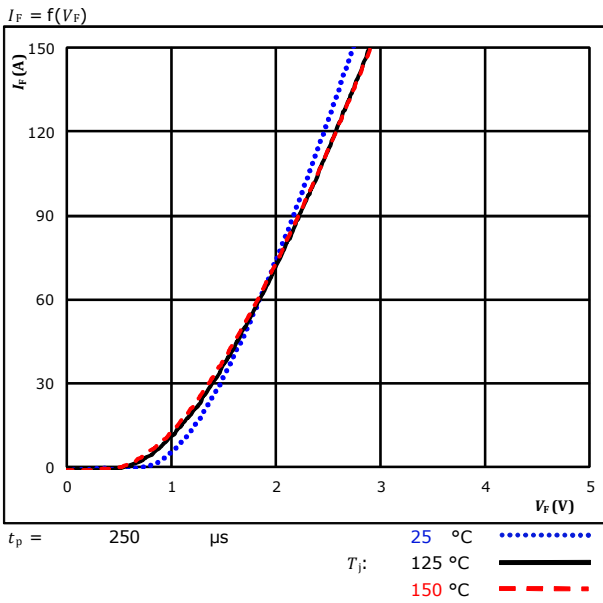
At

- $D =$ single pulse
- $T_s =$ 80 °C
- $V_{GE} =$ ±15 V
- $T_j =$ T_{jmax}

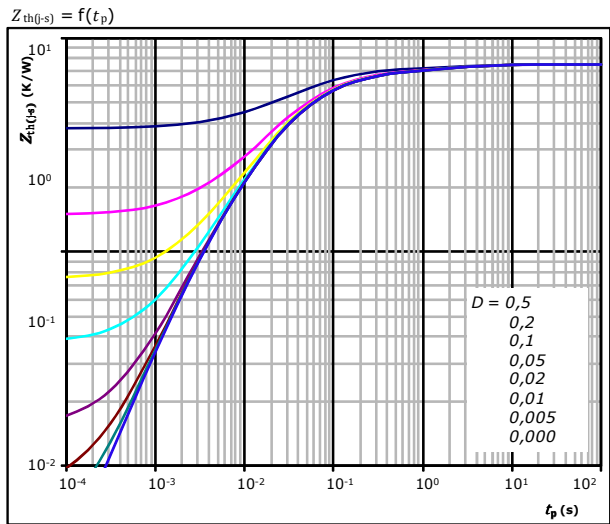


Inverter Diode Characteristics

Typical forward characteristics FWD



Transient thermal impedance as a function of pulse width FWD



$D = t_p / T$
 $R_{th(0-s)} = 0,75 \text{ K/W}$

FWD thermal model values

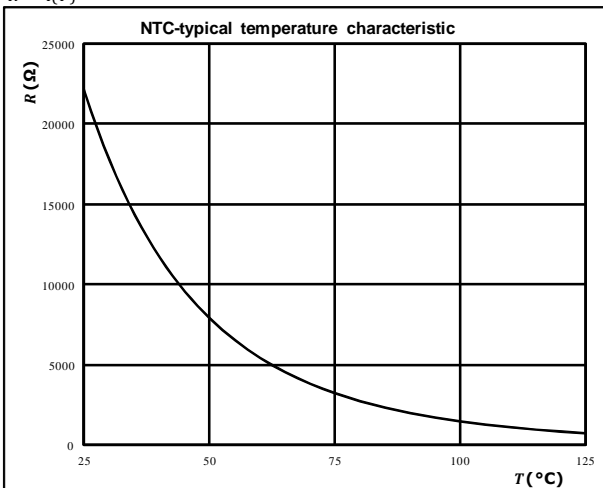
R (K/W)	τ (s)
4,26E-02	3,64E+00
6,76E-02	6,18E-01
2,53E-01	8,65E-02
3,23E-01	2,11E-02
6,24E-02	3,47E-03

Thermistor Characteristics

figure 1. Thermistor

Typical NTC characteristic as a function of temperature

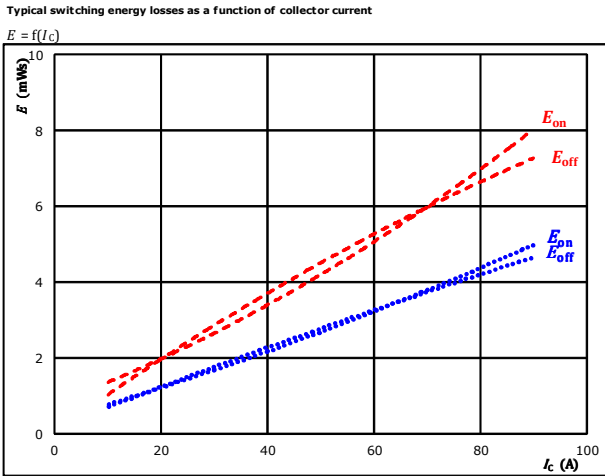
$R = f(T)$





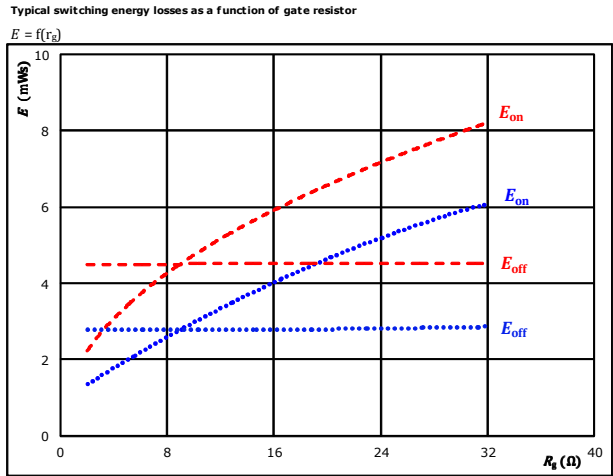
Inverter Switching Characteristics

Figure 1. IGBT
Typical switching energy losses as a function of collector current



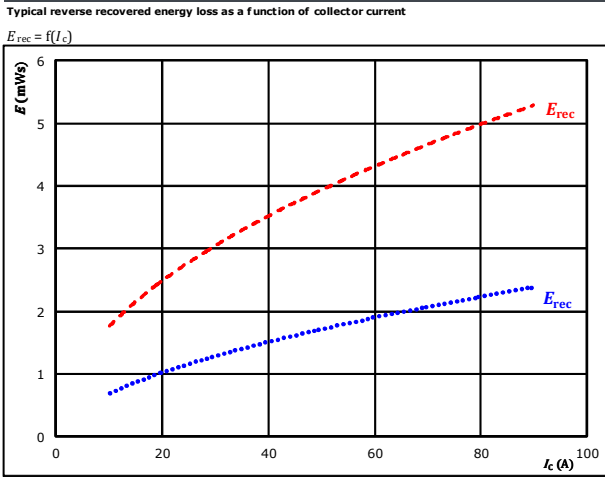
With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω
 $R_{goff} = 8$ Ω
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

Figure 2. IGBT
Typical switching energy losses as a function of gate resistor



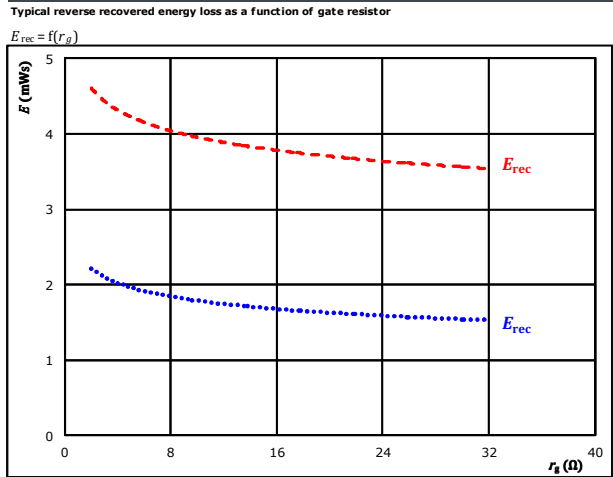
With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 50$ A
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

Figure 3. FWD
Typical reverse recovered energy loss as a function of collector current



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

Figure 4. FWD
Typical reverse recovered energy loss as a function of gate resistor



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 50$ A
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

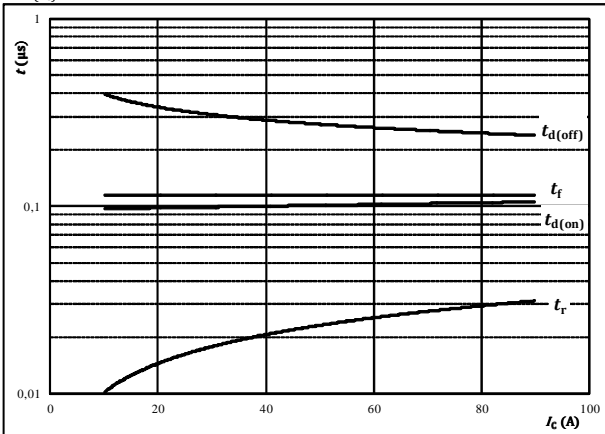


Inverter Switching Characteristics

Figure 5. IGBT

Typical switching times as a function of collector current

$$t = f(I_c)$$



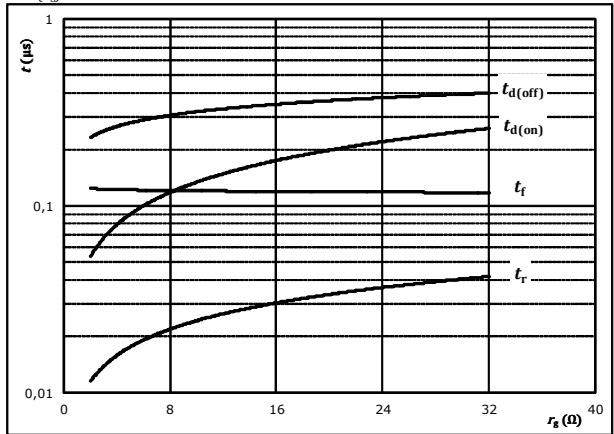
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	8	Ω
$R_{goff} =$	8	Ω

Figure 6. IGBT

Typical switching times as a function of gate resistor

$$t = f(r_g)$$



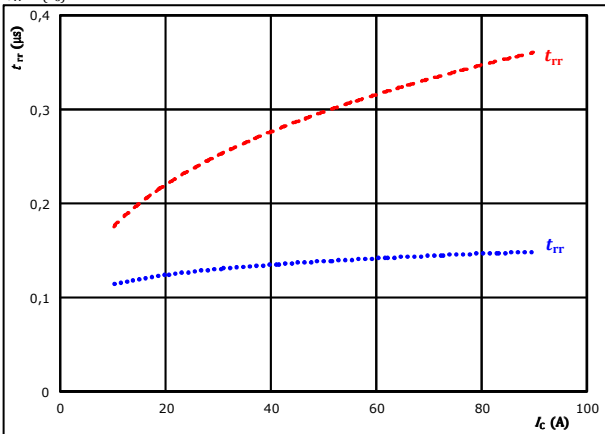
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_c =$	50	A

Figure 7. FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_c)$$



At

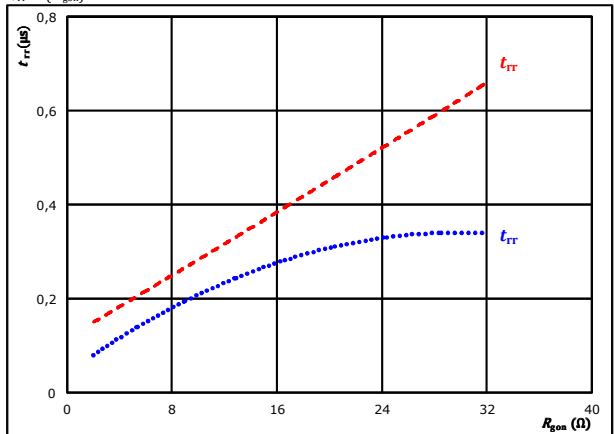
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	8	Ω

$T_j:$	25 °C
	150 °C	-----

Figure 8. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



At

$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_c =$	50	A

$T_j:$	25 °C
	150 °C	-----



Inverter Switching Characteristics

Figure 9. FWD

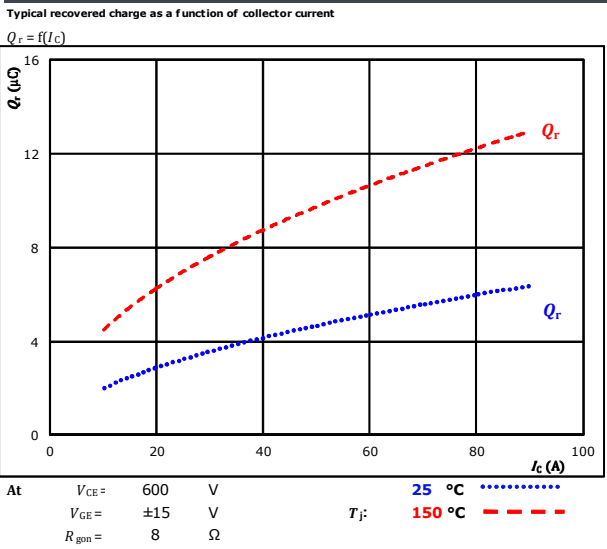


Figure 10. FWD

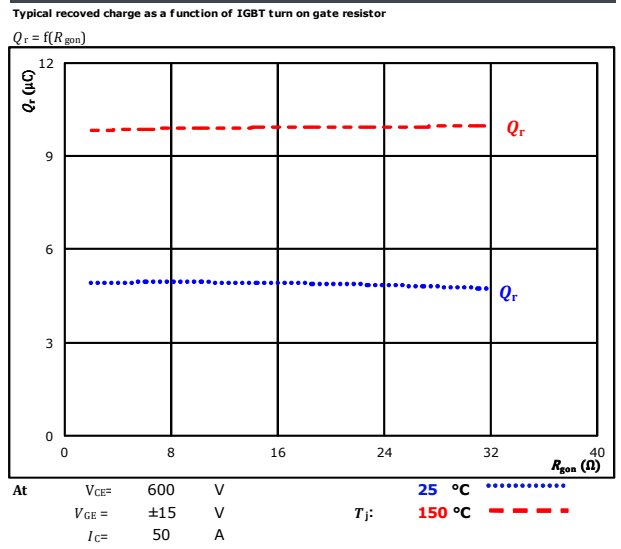


Figure 11. FWD

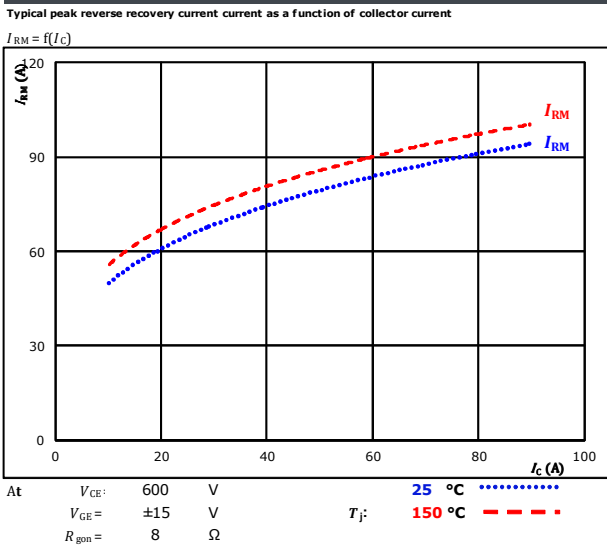
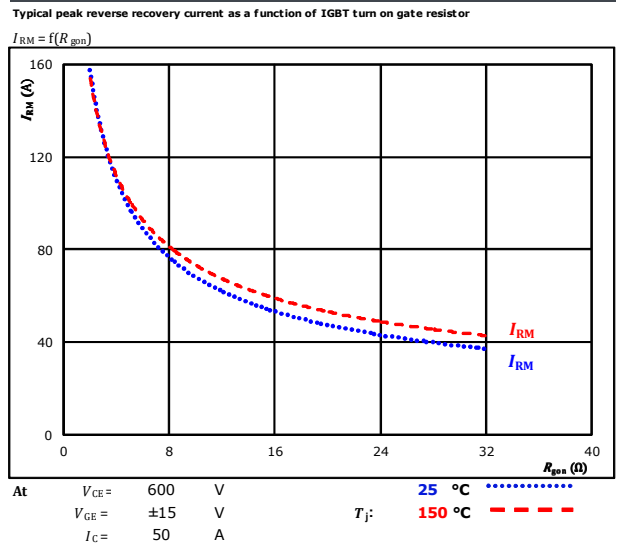


Figure 12. FWD

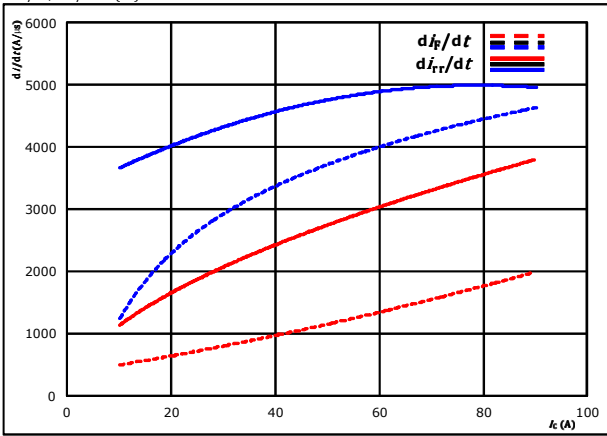




Inverter Switching Characteristics

Figure 13. FWD

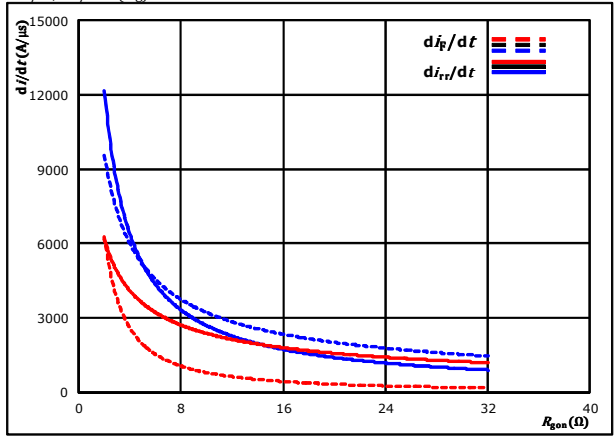
Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



At $V_{CE} = 600$ V $T_j = 25$ °C (dotted blue)
 $V_{GE} = \pm 15$ V $T_j = 150$ °C (dashed red)
 $R_{gon} = 8$ Ω

Figure 14. FWD

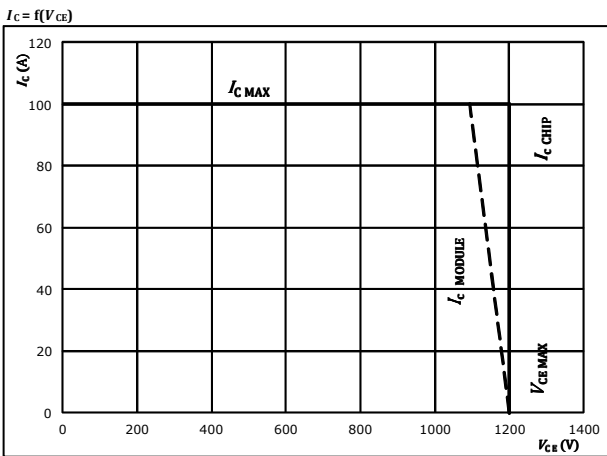
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_g)$



At $V_{CE} = 600$ V $T_j = 25$ °C (dotted blue)
 $V_{GE} = \pm 15$ V $T_j = 150$ °C (dashed red)
 $I_c = 50$ A

Figure 15. IGBT

Reverse bias safe operating area



At $T_j = 175$ °C
 $R_{gon} = 8$ Ω
 $R_{goff} = 8$ Ω



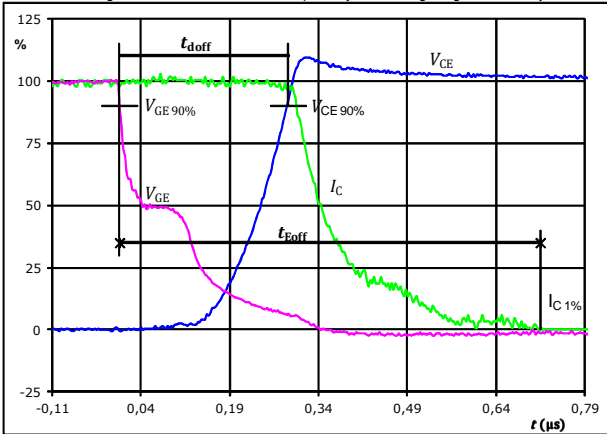
Inverter Switching Characteristics

General conditions

T_j	=	150 °C
R_{gon}	=	8 Ω
R_{goff}	=	8 Ω

Figure 1. IGBT

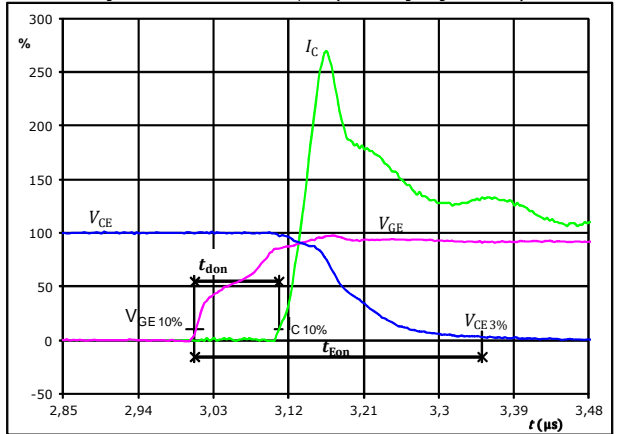
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})



$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	50	A
$t_{doff} =$	0,281	μs
$t_{Eoff} =$	0,710	μs

Figure 2. IGBT

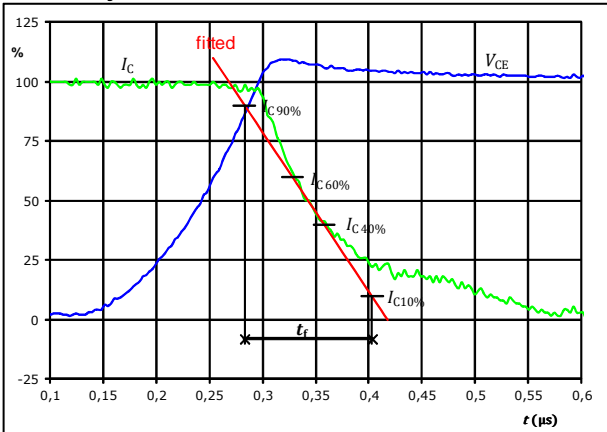
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})



$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	50	A
$t_{don} =$	0,101	μs
$t_{Eon} =$	0,345	μs

Figure 3. IGBT

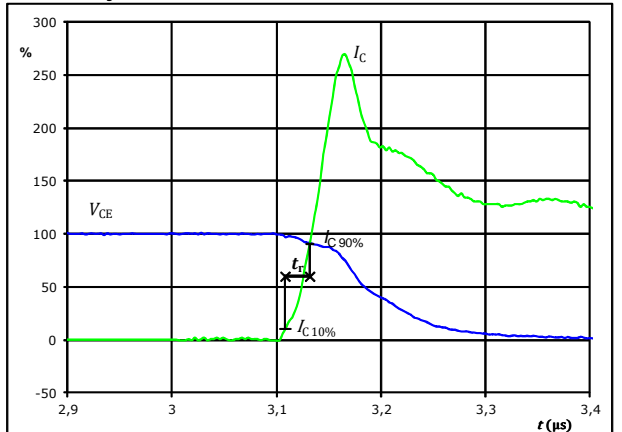
Turn-off Switching Waveforms & definition of t_f



$V_C(100\%) =$	600	V
$I_C(100\%) =$	50	A
$t_f =$	0,122	μs

Figure 4. IGBT

Turn-on Switching Waveforms & definition of t_r



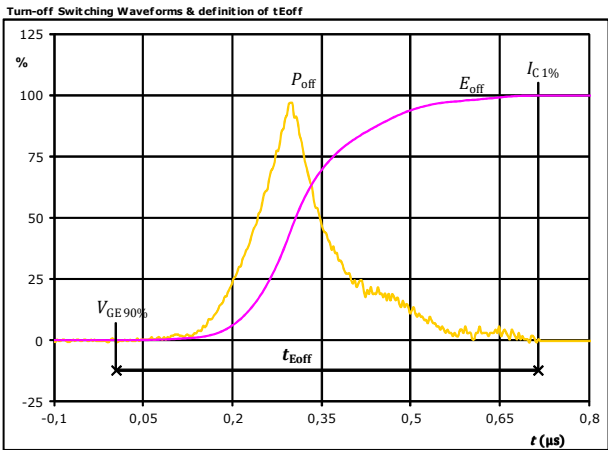
$V_C(100\%) =$	600	V
$I_C(100\%) =$	50	A
$t_r =$	0,024	μs



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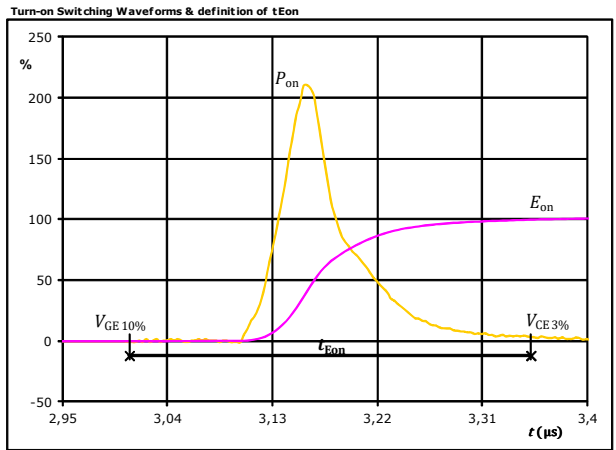
Inverter Switching Characteristics

Figure 5. IGBT



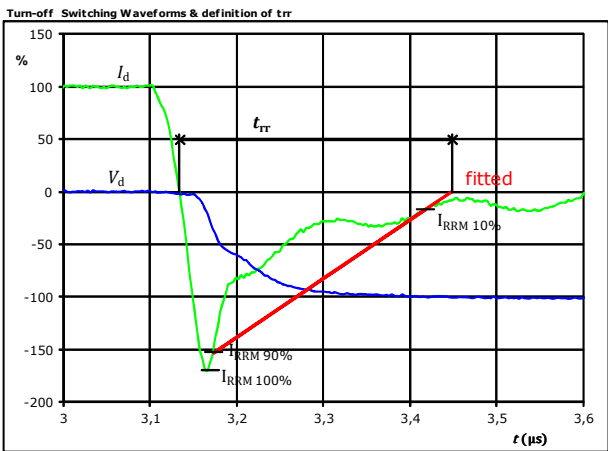
$P_{off}(100\%) =$	30,10	kW
$E_{off}(100\%) =$	4,53	mJ
$t_{Eoff} =$	0,71	μs

Figure 6. IGBT



$P_{on}(100\%) =$	30,10	kW
$E_{on}(100\%) =$	4,21	mJ
$t_{Eon} =$	0,345	μs

Figure 7. FWD

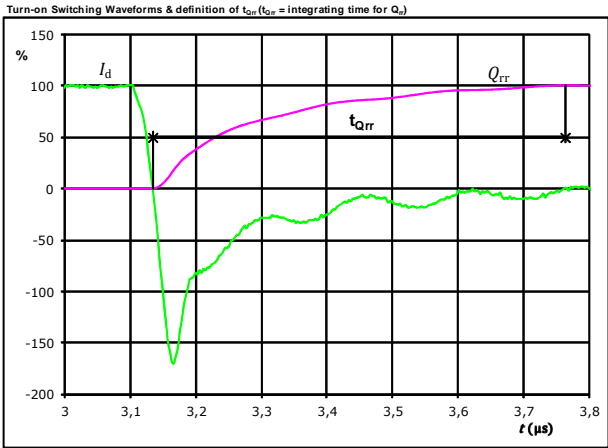


$V_d(100\%) =$	600	V
$I_d(100\%) =$	50	A
$I_{RRM}(100\%) =$	-85	A
$t_{rr} =$	0,316	μs



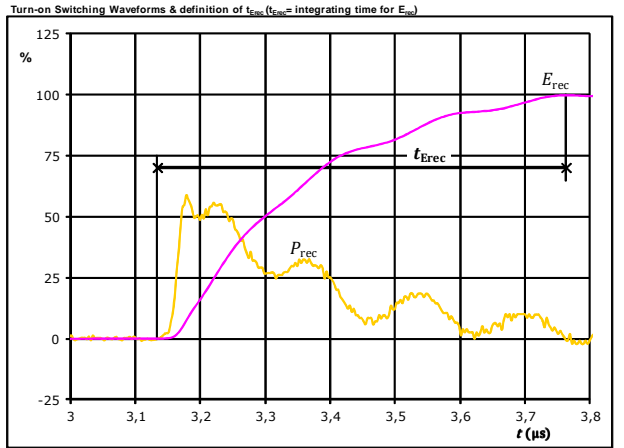
Inverter Switching Characteristics

Figure 8. FWD



I_d (100%) = 50 A
 Q_{rr} (100%) = 9,71 μC
 t_{Qrr} = 0,63 μs



Figure 9. FWD



P_{rec} (100%) = 30,10 kW
 E_{rec} (100%) = 3,97 mJ
 t_{Erec} = 0,63 μs

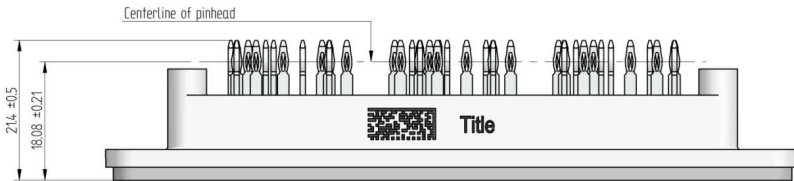
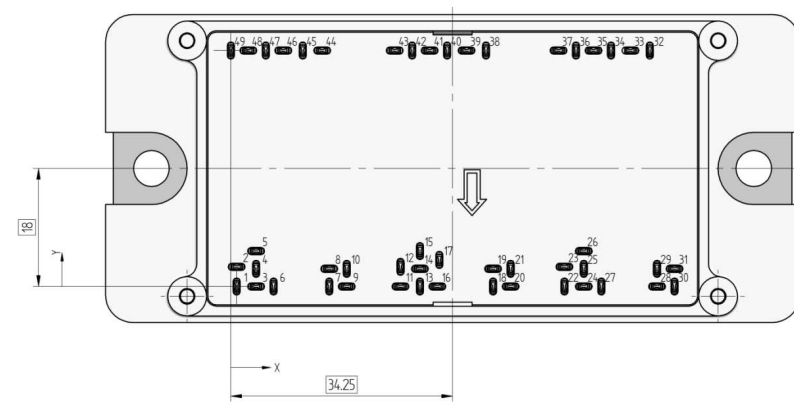


Vincotech

Ordering Code & Marking						
Version			Ordering Code			
without thermal paste 17 mm housing			30-P2126PA050SC-L287F09Y			
NN-NNNNNNNNNNNN TTTTTVVWWYY UL VIN LLLLL SSSS						
Text	Name		Date code	UL & VIN	Lot	Serial
	N-NNNNNNNNNNNNNN-TTTTTVV		WWYY	UL VIN	LLLLL	SSSS
Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTTVV	LLLLL	SSSS	WWYY		

Pin table [mm]			
Pin	X	Y	Function
1	0,9	0	S11
2	0,9	3	G11
3	3,9	0	DC-1
4	3,9	2,7	DC-1
5	3,9	5,4	DC-1
6	6,6	0	DC-1
7	15,2	0	DC+1
8	15,2	2,7	DC+1
9	17,9	0	DC+1
10	17,9	2,7	DC+1
11	26,2	0	S13
12	26,2	3	G13
13	29,2	0	DC-2
14	29,2	2,7	DC-2
15	29,2	5,4	DC-2
16	31,9	0	DC-2
17	32,2	4,05	NTC
18	40,5	0	DC+2
19	40,5	2,7	DC+2
20	43,2	0	DC+2
21	43,2	2,7	DC+2
22	51,5	0	S15
23	51,5	3	G15
24	54,5	0	DC-3
25	54,5	2,7	DC-3
26	54,5	5,4	DC-3
27	57,2	0	DC-3
28	65,8	0	DC+3
29	65,8	2,7	DC+3
30	68,5	0	DC+3
31	68,5	2,7	DC+3
32	64,7	36	G16
33	61,7	36	S16
34	58,7	36	PH3
35	56	36	PH3
36	53,3	36	PH3
37	50,6	36	PH3
38	39,4	36	G14
39	36,4	36	S14
40	33,4	36	PH2
41	30,7	36	PH2
42	28	36	PH2
43	25,3	36	PH2
44	14,1	36	G12
45	11,1	36	S12
46	8,1	36	PH1
47	5,4	36	PH1
48	2,7	36	PH1
49	0	36	PH1

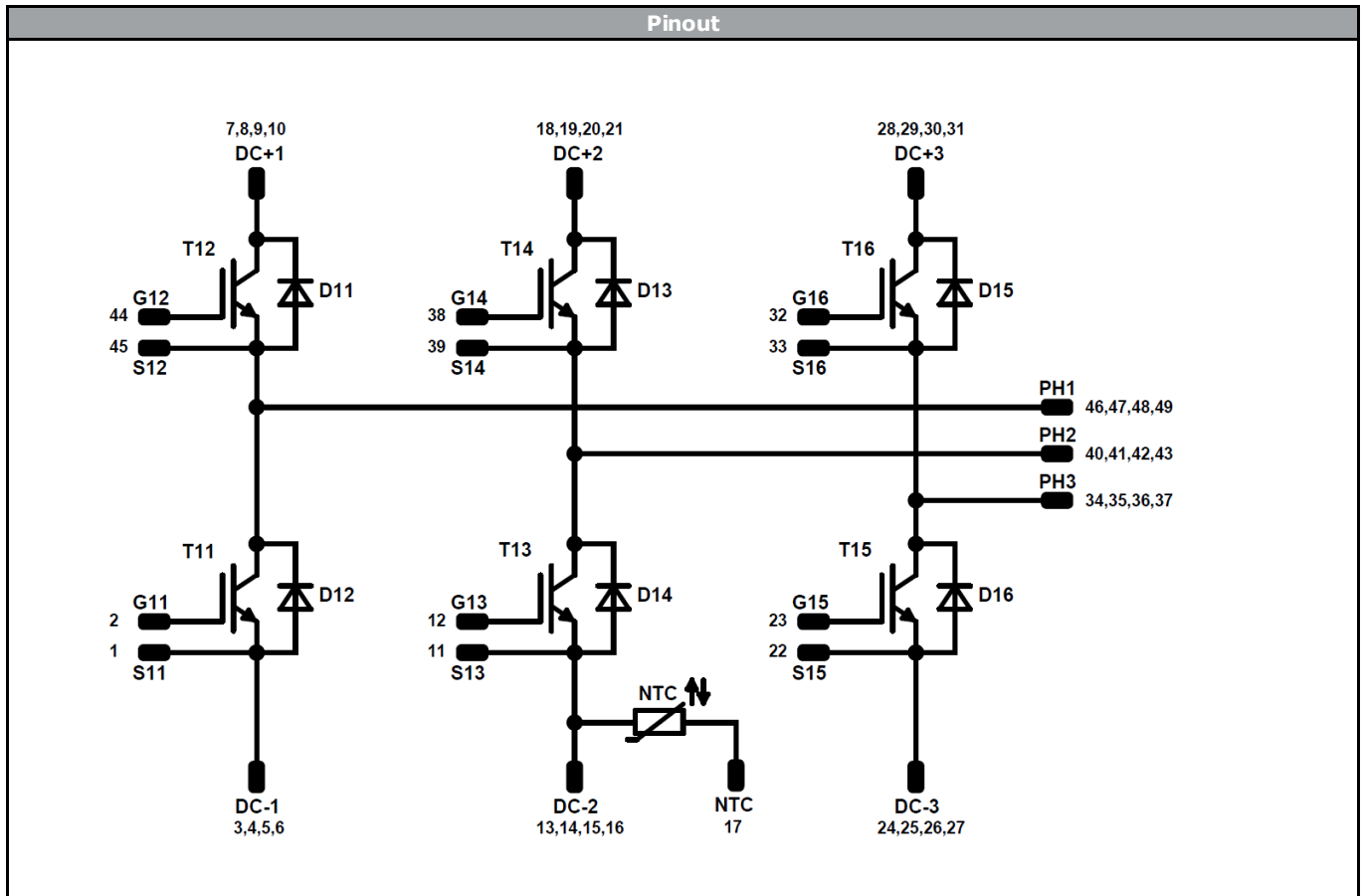
Outline

Tolerance of pinpositions: ±0.5 mm at the end of pins.
Dimension of coordinate axis is only offset without tolerance



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Identification					
ID	Component	Voltage	Current	Function	Comment
T11 , T12 , T13 , T14 , T15 , T16	IGBT	1200 V	50 A	Inverter Switch	
D11 , D12 , D13 , D14 , D15 , D16	FWD	1200 V	50 A	Inverter Diode	
Rt	Thermistor			Thermistor	




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Packaging instruction			
Standard packaging quantity (SPQ) 36	>SPQ	Standard	<SPQ Sample

Handling instruction
Handling instructions for <i>flow 2</i> packages see vincotech.com website.

Package data
Package data for <i>flow 2</i> packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
30-x2126PA050SC-L287F09x-D2-14	19 Apr. 2017		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.